

## RX610 Group

### On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)

R01AN0180EJ0100

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#### Introduction

This application note describes the processing used to transfer, using asynchronous serial communication, the erase block number, write data size, and write data to the program described in the RX610 Group application note titled “On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Slave)” (R01AN0179EJ). See the “On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Slave)” RX610 Group application note for details on erasing and programming the internal flash memory (the user MAT) in the slave.

#### Target Device

RX610 Group

This program can be used with other RX Family MCUs that have the same I/O registers (peripheral device control registers) as the RX610 Group. Check the latest version of the manual for any additions and modifications to functions. Careful evaluation is recommended before using this application note.

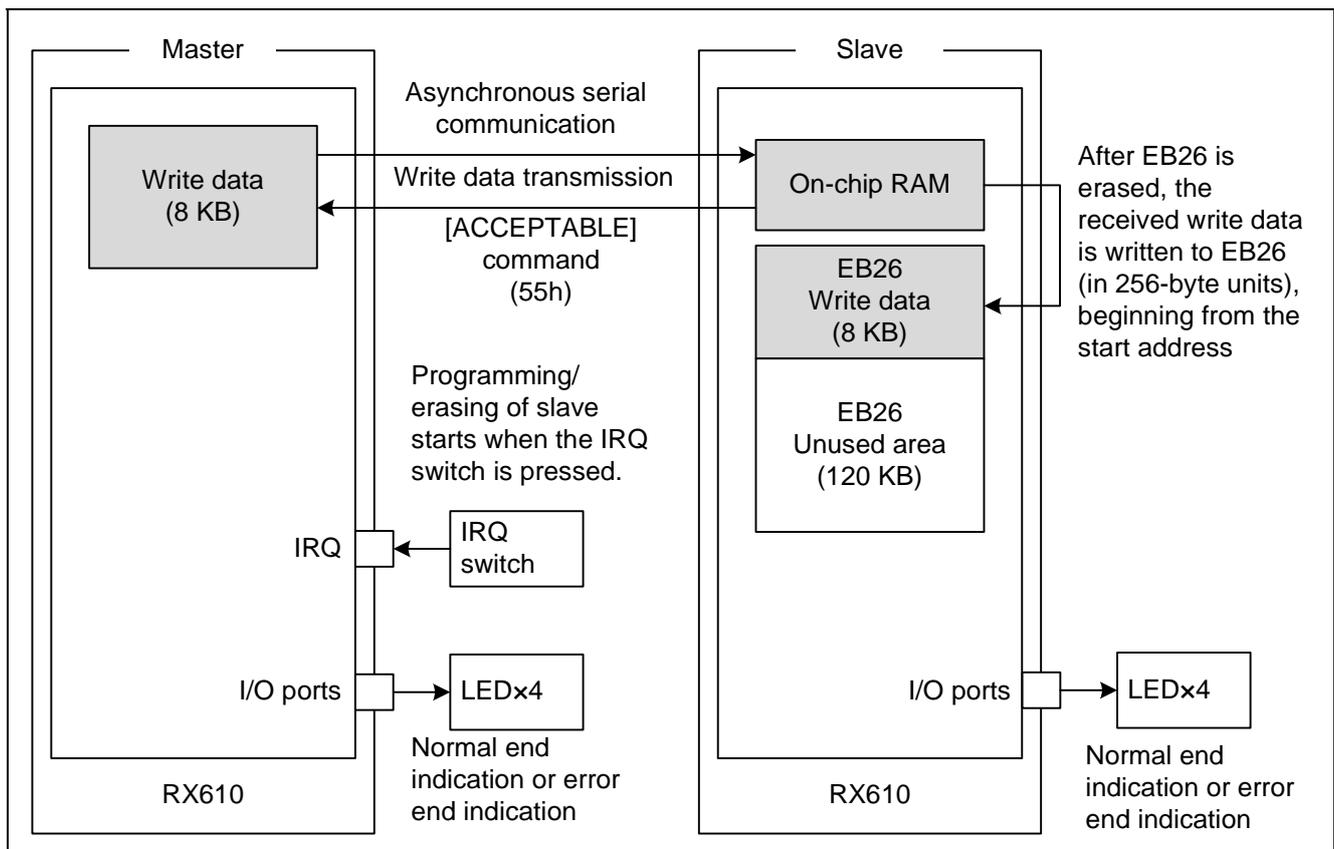
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## 1. Specifications

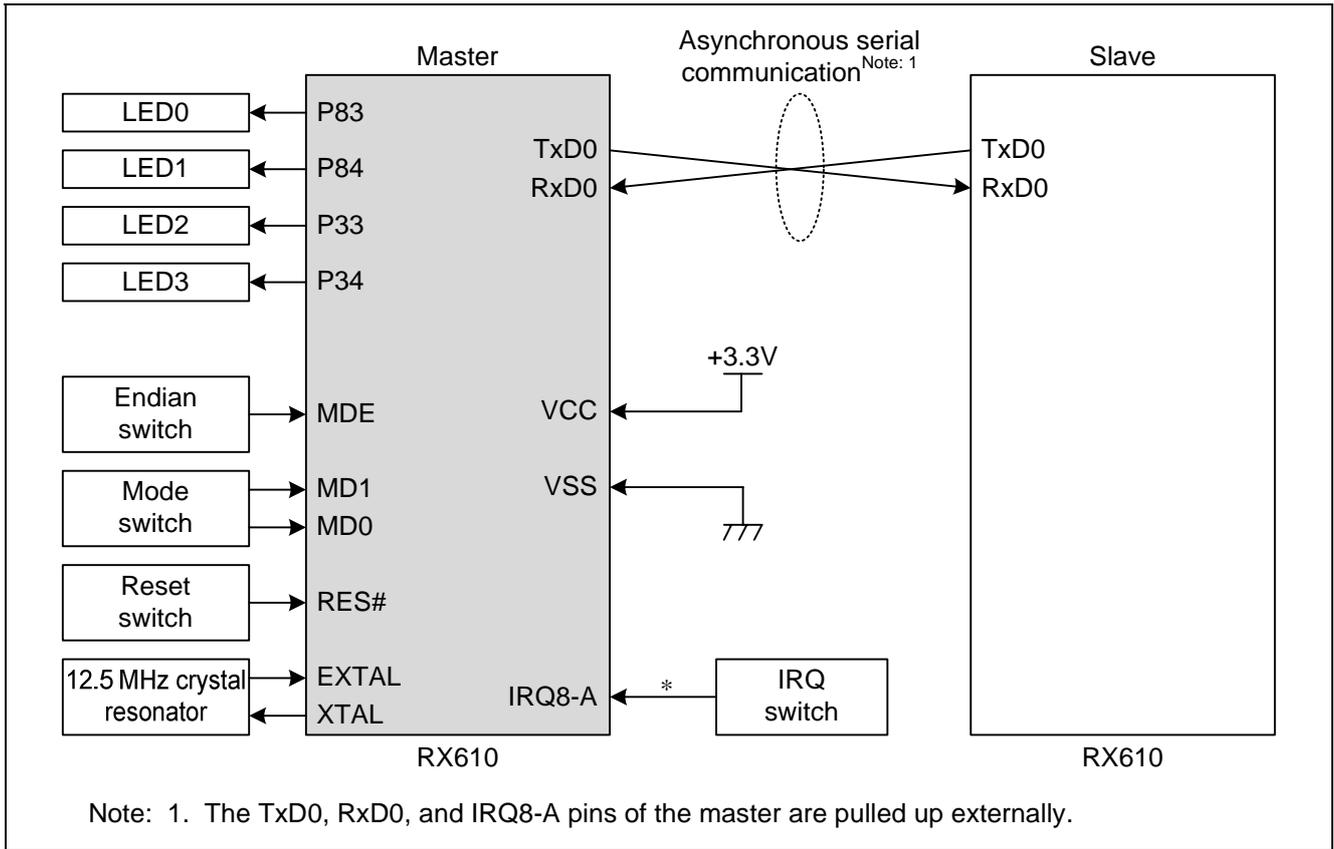
- The master sends the erase block number, the write data size, and the write data to the slave using asynchronous serial communication and the slave programs its own user MAT.
- The SCI channel 0 (SCI0) module is used for asynchronous serial communication between the master and the slave.
- Asynchronous serial communication specifications
  - Bit rate: 31,250 bps
  - Data length: 8 bits
  - Parity bits: none
  - Stop bits: 1 bit
- When the switch connected to the master's external interrupt pin (IRQ8-A) is pressed, the master starts serial communications and controls programming of the slave's user MAT.
- Using communication commands, the master tells the slave which one of its user MAT erase blocks (EB00 to EB27) to erase. In this application note, the slave is told to erase the EB26 erase block.
- After the slave completes erasing EB26, the master transmits the write data size (4 bytes) and the write data (8 KB) to the slave.
- Handshaking is used to control communication between the master and slave. In particular, after sending a transmission to the slave, the master waits until an [ACCEPTABLE] (55h) command is returned. After receiving an [ACCEPTABLE] (55h) command, the master starts the next communication.
- When the slave has successfully reprogrammed the user MAT, the master reports the successful completion in the four LEDs connected to its I/O ports. Also, if an error occurs in the slave during communication, the slave will report that error with its LEDs.

Figure 1 shows the specifications of the system used in this application note.



**Figure 1 Specifications**

Figure 2 shows a hardware configuration diagram of the master device as used in this application note.



**Figure 2 Hardware Configuration Diagram of Master Device**

## 2. Operation Confirmation Environment

Table 1 lists the environment required for confirming master operation.

**Table 1 Master Operation Confirmation Environment**

<b>Item</b>	<b>Description</b>
Device	RX610 Group: R5F56108VNFP (ROM: 2 MB, RAM: 128 KB)
Board	Evaluation board
Power supply voltage	5.0 V (CPU operating voltage: 3.3 V)
Input clock	12.5 MHz (ICLK = 100 MHz, PCLK = 50 MHz, BCLK = 25 MHz)
Operating temperature	Room temperature
HEW	Version 4.07.00.007
Toolchain	RX Standard Toolchain (V.1.0.0.0)
Debugger/Emulator	E20 Emulator
Debugger component	RX E20 SYSTEM V.1.00.00.000

## 3. Functions Used

- Clock generation circuit
- Low Power Consumption
- Interrupt control unit
- I/O ports
- Serial Communications Interface (SCI)

For details, see the Hardware Manual listed in 7, Reference Documents.

## 4. Operation

### 4.1 Operation Mode Settings

In the sample program, the master's mode pins are set to MD1 = 1, MD0 = 1 to select single-chip mode as the operating mode, the ROME bit in system control register 0 (SYSCR0) is set to 1 to enable the on-chip ROM, and the EXBE bit in the SYSCR0 register is cleared to 0 to disable the external bus.

The master is activated from the user MAT in single-chip mode.

Table 2 lists the master operating mode settings used in the sample program.

**Table 2 Operating Mode Settings of Master Device**

Mode Pin		SYSCR0 Register		Operating Mode	On-Chip ROM	External Bus
MD1	MD0	ROME	EXBE			
1	1	1	0	Single-chip mode	Enabled	Disabled

Note: The initial settings of the ROME and EXBE bits in the SYSCR0 register are SYSCR0.ROME = 1 and SYSCR0.EXBE = 0, so it is not necessary for the sample program to make settings to the SYSCR0 register.

### 4.2 Clock Settings

The evaluation board used for this application note includes a 12.5 MHz crystal oscillator.

Therefore this application note uses the following settings for the system clock (ICLK), the peripheral module clock (PCLK), and the external bus clock (BCLK): 8× (100 MHz), 4× (50 MHz), and 2× (25 MHz).

### 4.3 Endian Mode Setting

The sample program presented in this application note supports both big- and little-endian mode. Table 3 lists the hardware (MDE pin) endian mode settings of the master device. Note that the master and slave endian settings must match.

**Table 3 Endian Mode Settings of Master Device (Hardware)**

MDE pin	Endian
0	Little endian
1	Big endian

Table 4 lists the endian settings used in the compiler options.

**Table 4 Endian Mode Settings of Master Device (Compiler Options)**

MCU Option	Endian
endian = little	Little endian
endian = big	Big endian

Note: Set the MDE bit to match the endian mode selected as a compiler option.

## 4.4 Asynchronous Serial Communication Specifications

In the program described in this application note, asynchronous serial communication is used to transmit communication commands, the erase block number, the write data size, and the write data. Note that the slave transmits the [ACCEPTABLE] command (55h) as a status command for handshaking. The SCI0, TxD0, and RxD0 pins used are pulled up externally.

Table 5 shows the specifications of the asynchronous serial communication used here.

**Table 5 Asynchronous Serial Communication Specifications**

Item	Description
Channel	SCI channel 0 (SCI0)
Communication mode	Asynchronous mode
Bit rate	31,250 bps (PCLK = 50 MHz)
Data length	8 bits
Parity bit	None
Stop bit	1 bit
Error	Overrun error, framing error

### 4.4.1 Communication Command Specifications

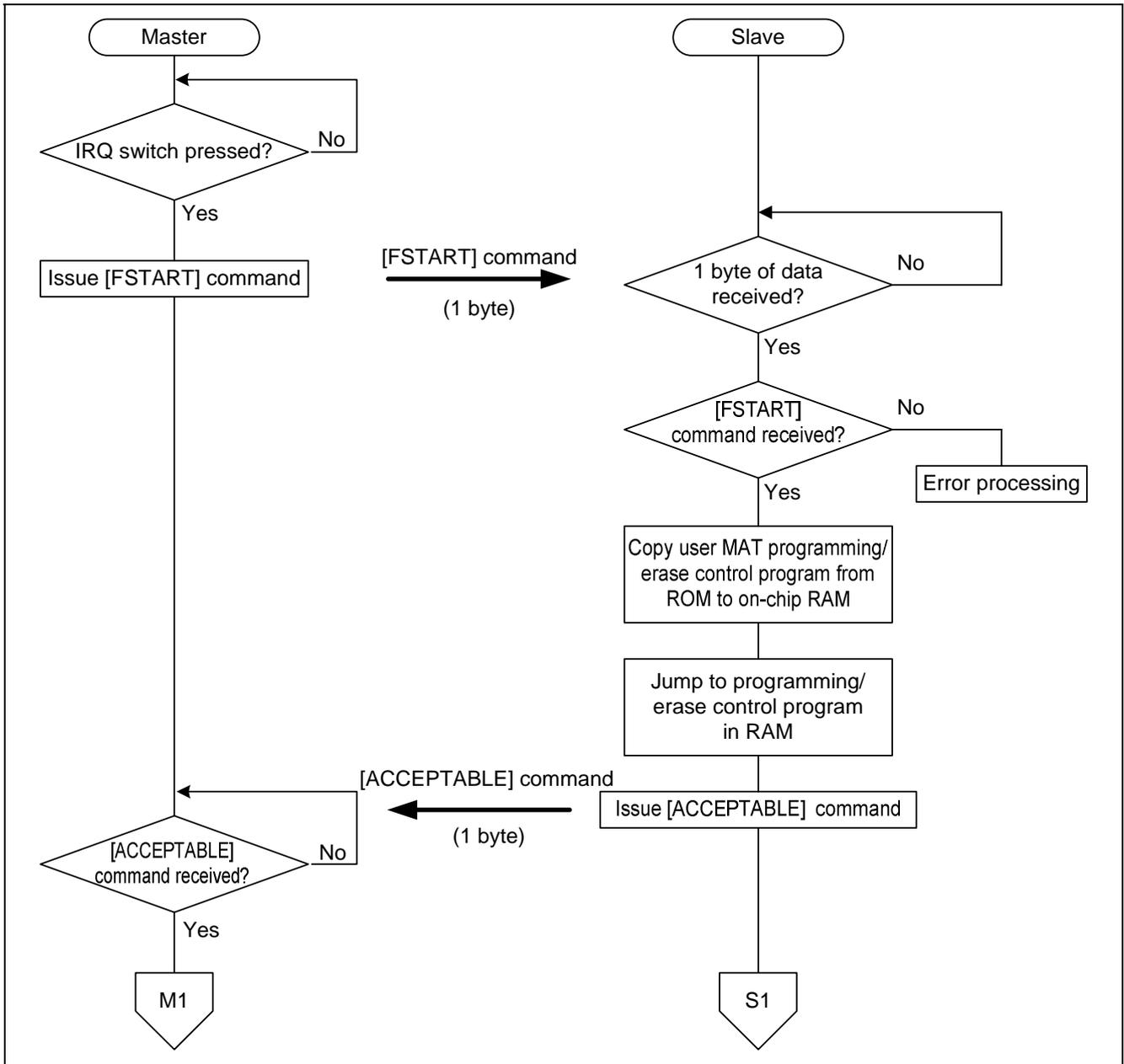
Table 6 lists the specifications of the communication commands sent between the master and slave.

**Table 6 Communication Command Specifications**

Command	Value	Description	Communication Direction
FSTART	10h	Command to start programming/erasing of the user MAT of the slave	Master → slave
ERASE	11h	Command to start erasing of the user MAT of the slave	Master → slave
WRITE	12h	Command to start programming of the user MAT of the slave	Master → slave
ACCEPTABLE	55h	Status command used by the slave to inform the master that it is able to receive data from the master.	Slave → master

**4.4.2 Communication Sequence**

Figures 3 to 6 show the communication sequence between master and slave.



**Figure 3 Communication Sequence (1)**

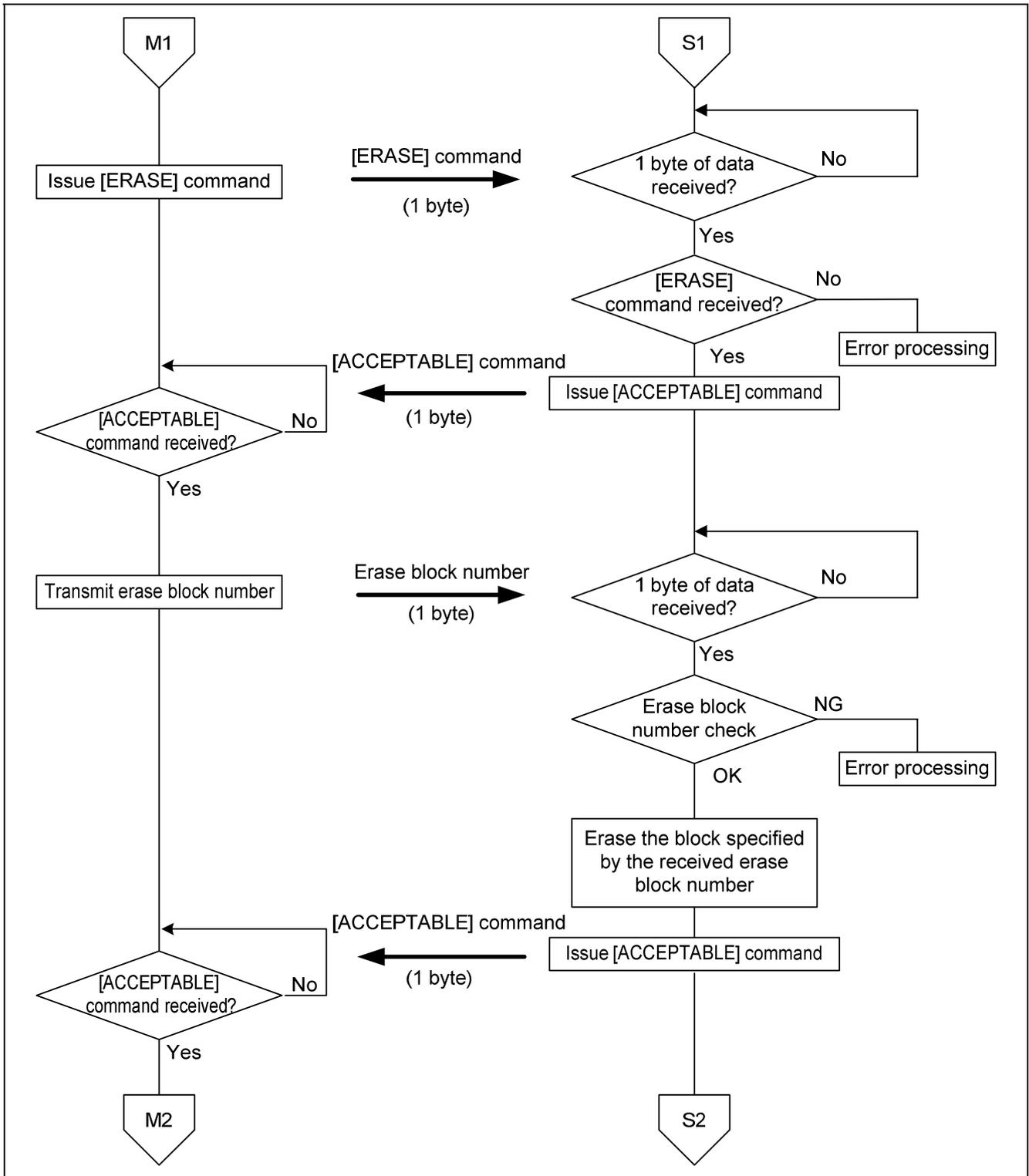
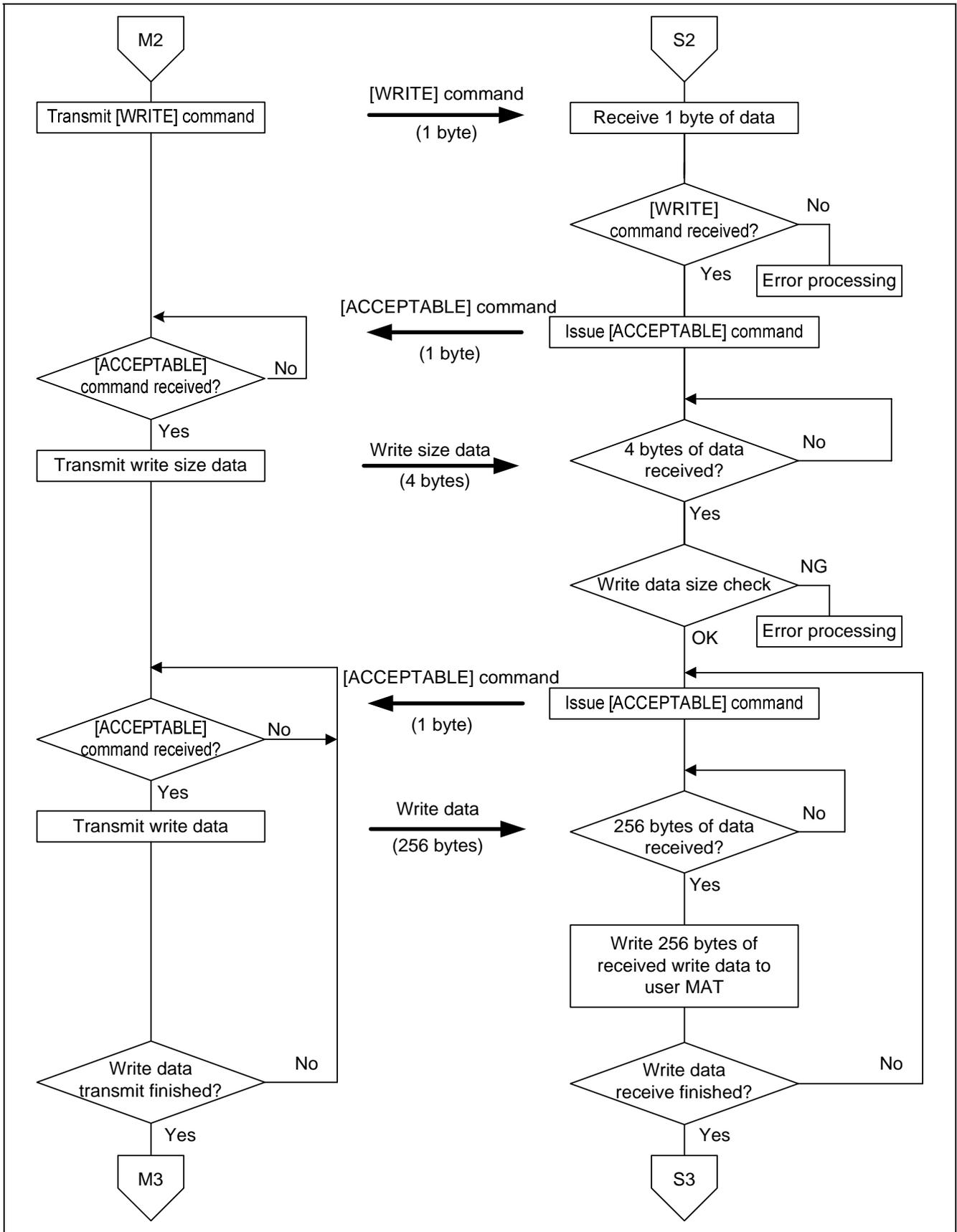
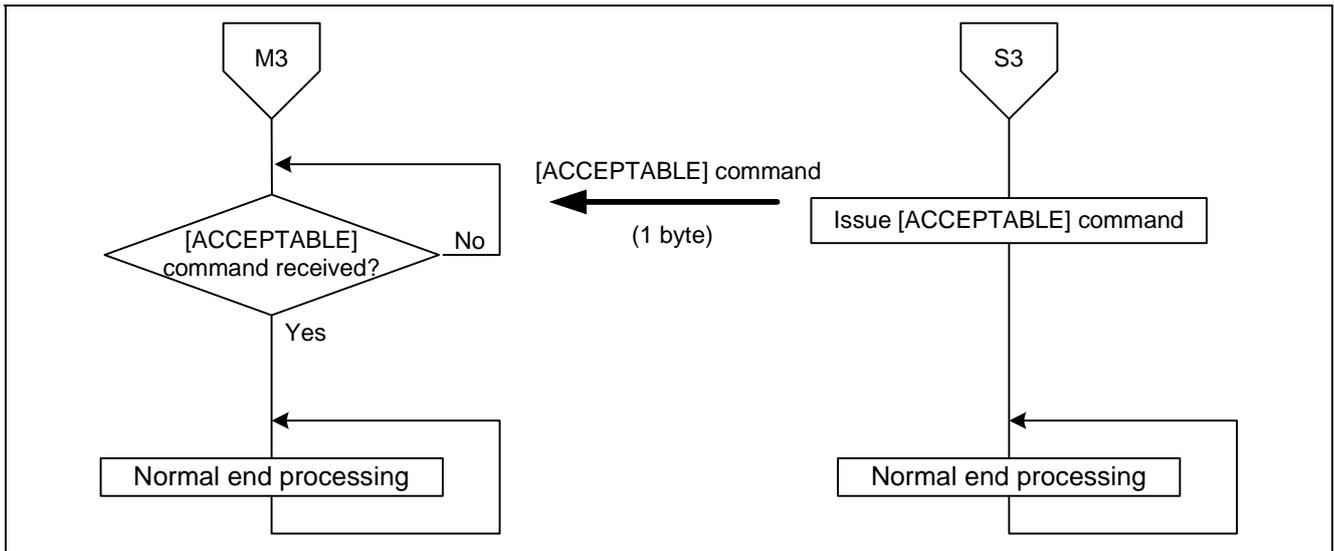


Figure 4 Communication Sequence (2)



**Figure 5 Communication Sequence (3)**



**Figure 6 Communication Sequence (4)**

### 4.4.3 Erasure Block Number

After transmitting an [ERASE] command, the master transmits 1 byte of erasure block number (1 byte of data defined by a symbolic constant). Table 7 lists the erasure block number values. Figure 7 shows the specifications of the erasure block number.

**Table 7 Erasure Block Number Values**

Erasure Block Number		
Symbolic Constant	Value	Description
EB27_INDEX	00h	Specifies erasure block EB27 (size: 128 KB)
EB26_INDEX	01h	Specifies erasure block EB26 (size: 128 KB)
EB25_INDEX	02h	Specifies erasure block EB25 (size: 128 KB)
EB24_INDEX	03h	Specifies erasure block EB24 (size: 128 KB)
EB23_INDEX	04h	Specifies erasure block EB23 (size: 128 KB)
EB22_INDEX	05h	Specifies erasure block EB22 (size: 128 KB)
EB21_INDEX	06h	Specifies erasure block EB21 (size: 128 KB)
EB20_INDEX	07h	Specifies erasure block EB20 (size: 128 KB)
EB19_INDEX	08h	Specifies erasure block EB19 (size: 128 KB)
EB18_INDEX	09h	Specifies erasure block EB18 (size: 128 KB)
EB17_INDEX	0Ah	Specifies erasure block EB17 (size: 128 KB)
EB16_INDEX	0Bh	Specifies erasure block EB16 (size: 64 KB)
EB15_INDEX	0Ch	Specifies erasure block EB15 (size: 64 KB)
EB14_INDEX	0Dh	Specifies erasure block EB14 (size: 64 KB)
EB13_INDEX	0Eh	Specifies erasure block EB13 (size: 64 KB)
EB12_INDEX	0Fh	Specifies erasure block EB12 (size: 64 KB)
EB11_INDEX	10h	Specifies erasure block EB11 (size: 64 KB)
EB10_INDEX	11h	Specifies erasure block EB10 (size: 64 KB)
EB09_INDEX	12h	Specifies erasure block EB09 (size: 64 KB)
EB08_INDEX	13h	Specifies erasure block EB08 (size: 64 KB)
EB07_INDEX	14h	Specifies erasure block EB07 (size: 8 KB)
EB06_INDEX	15h	Specifies erasure block EB06 (size: 8 KB)
EB05_INDEX	16h	Specifies erasure block EB05 (size: 8 KB)
EB04_INDEX	17h	Specifies erasure block EB04 (size: 8 KB)
EB03_INDEX	18h	Specifies erasure block EB03 (size: 8 KB)
EB02_INDEX	19h	Specifies erasure block EB02 (size: 8 KB)
EB01_INDEX	1Ah	Specifies erasure block EB01 (size: 8 KB)
EB00_INDEX	1Bh	Specifies erasure block EB00 (size: 8 KB)

Erasure block number (unsigned char type)

b7	b6	b5	b4	b3	b2	b1	b0
BD7	BD6	BD5	BD4	BD3	BD2	BD1	BD0

The sample program presented in this application note programs and erases erasure block EB26 of the slave, so the erasure block number value is [EB26\_INDEX(01h)].

Note: A value shown in table 7, [EB27\_INDEX(00h)] to [EB00\_INDEX(1Bh)], should be specified as the erasure block number. If a value of [1Ch] to [FFh] is specified as the erasure block number, the slave determines an error to have occurred and error handling takes place.

**Figure 7 Erasure Block Number Specifications**

**4.4.4 Write Data Size**

After transmitting a [WRITE] command, the master transmits 4 bytes of write data size. Figure 8 shows the specifications of the write data size.

Write data size (unsigned long type)

b31	b30	b29	b28	b27	b26	b25	b24
SZ31	SZ30	SZ29	SZ28	SZ27	SZ26	SZ25	SZ24
b23	b22	b21	b20	b19	b18	b17	b16
SZ23	SZ22	SZ21	SZ20	SZ19	SZ18	SZ17	SZ16
b15	b14	b13	b12	b11	b10	b9	b8
SZ15	SZ14	SZ13	SZ12	SZ11	SZ10	SZ09	SZ08
b7	b6	b5	b4	b3	b2	b1	b0
SZ07	SZ06	SZ05	SZ04	SZ03	SZ02	SZ01	SZ00

The sample program uses a write size of 8 KB, so the write data size value is [0000 2000h].

- Notes:
1. The write data size must be greater than zero and less than or equal to the erase block size for the specified erase block. If 0 or a value greater than the erase block size is specified, the slave will recognize an error and perform error handling.
  2. The size of write data transmissions is fixed at 256 bytes. Consequently, if the write data size specifies a value that is not a multiple of 256 bytes, the master transmits write data in units of 256 bytes and then fills in the final unit of write data, which is less than 256 bytes, with bytes of value FFh as padding to reach a total of 256 bytes, which it transmits to the slave.

**Figure 8 Write Data Size Specifications**

#### **4.4.5 Overrun Error**

In this application note, if an overrun error occurs during master asynchronous serial communication reception (the SCI0.SSR.ORER bit is set to 1), the master will perform error handling.

#### **4.4.6 Framing Error**

In this application note, if a framing error occurs during master asynchronous serial communication reception (the SCI0.SSR.FER bit is set to 1), the master will perform error handling.

### **4.5 Normal End Processing**

When reprogramming the slave's user MAT has completed normally, the master indicates that normal completion in the four connected LEDs. The normal end indication consists of LED0 to LED3 illuminating one after another in a sequence that is repeated multiple times.

### **4.6 Error Handling**

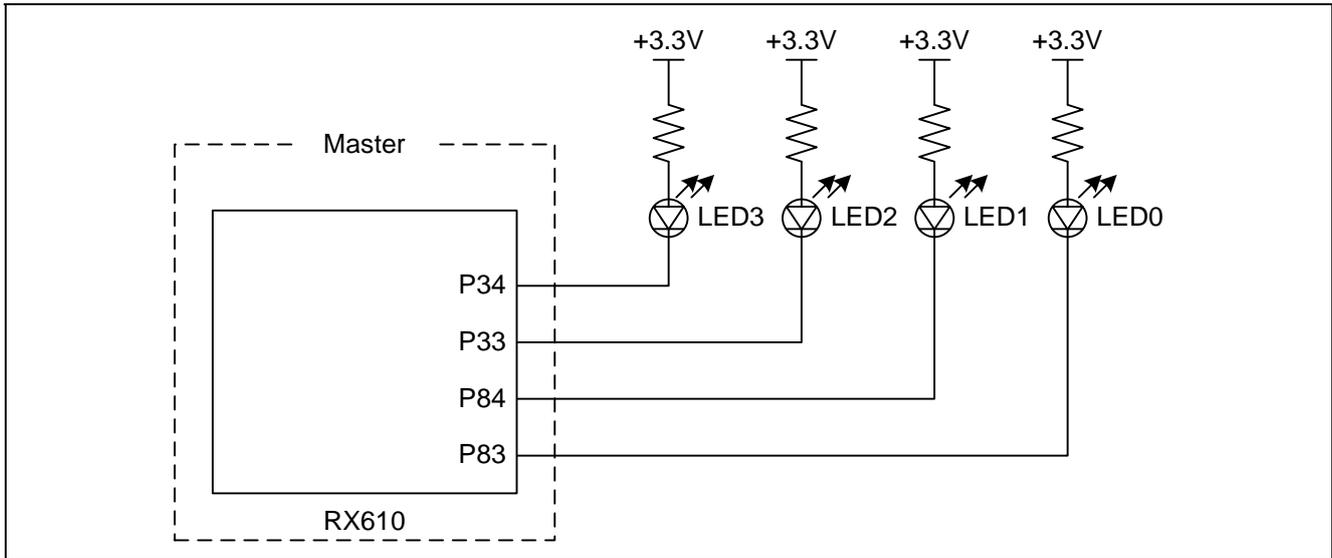
Table 8 lists the LED display shown when an error occurs in the master in this application note. The master's error handling routine displays the error state in the four LEDs.

**Table 8 LED Display when an Error Occurs in the Master**

<b>Error No.</b>	<b>Description</b>	<b>LED Indication</b>			
		<b>LED3</b>	<b>LED2</b>	<b>LED1</b>	<b>LED0</b>
Error No. 01	An overrun or framing error occurred.	Off	Off	Off	On

**4.7 LED Connections**

Figure 9 shows the connections of the master I/O ports and LED0 to LED3.



**Figure 9 Master Device LED Connection Diagram**

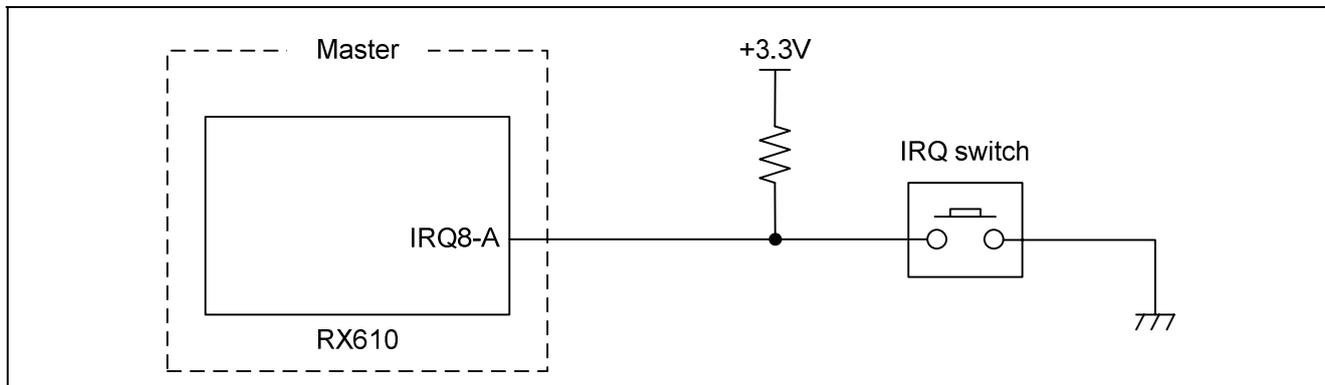
As shown in figure 9, high-level output from an I/O port (P83, P84, P33, or P34) causes the corresponding LED among LED0 to LED3 to turn off, and low-level output causes the corresponding LED to illuminate. Table 9 shows the correspondence between I/O port output and LED states.

**Table 9 Master I/O Port Output and LED States**

I/O Port	Register Setting	I/O Port State	LED State
P83	PORT8.DR.B3 = 1, PORT8.DDR.B3 = 1	High-level output	LED0 Off
	PORT8.DR.B3 = 0, PORT8.DDR.B3 = 1	Low-level output	LED0 On
P84	PORT8.DR.B4 = 1, PORT8.DDR.B4 = 1	High-level output	LED1 Off
	PORT8.DR.B4 = 0, PORT8.DDR.B4 = 1	Low-level output	LED1 On
P33	PORT3.DR.B3 = 1, PORT3.DDR.B3 = 1	High-level output	LED2 Off
	PORT3.DR.B3 = 0, PORT3.DDR.B3 = 1	Low-level output	LED2 On
P34	PORT3.DR.B4 = 1, PORT3.DDR.B4 = 1	High-level output	LED3 Off
	PORT3.DR.B4 = 0, PORT3.DDR.B4 = 1	Low-level output	LED3 On

## 4.8 IRQ Switch

Figure 10 shows a diagram of the connection between the external interrupt pin (IRQ8-A) of the master and the IRQ switch. Programming/erasing of the user MAT of the slave starts when the IRQ switch connected to the master is pressed.



**Figure 10 Master IRQ Switch Connection Diagram**

The master determines that the IRQ switch is in the depressed state by detecting the falling edge of the IRQ8-A pin. No interrupt handling is performed, and the determination of the IRQ switch state is made by detecting that the IRQ8 interrupt status flag (bit IR in IR072) has been set to 1.

## 4.9 Handshaking Control

The master uses handshaking with the slave for communications control.

Handshaking control in the master consists of waiting after serial communication until an [ACCEPTABLE] command (55h) is received from the slave. The master only starts the next serial communication after it has received an [ACCEPTABLE] command from the slave.

## 4.10 Section Settings

Table 10 shows the section settings for the master device.

**Table 10 Section Settings of Master Device**

Section	Start Address	Description
B	000 1000h	Uninitialized data area (ALIGN = 4)
R		Area in RAM to which [D] section is mapped by ROM option
SU		User stack area
SI		Interrupt stack area
CP_DATA_1	FFFF C000h	Constant area (ALIGN = 1) (write data (8 bytes))
PResetPRG	FFFF E000h	Program area (PowerON_Reset_PC program)
C	FFFF E100h	Constant area (ALIGN = 4)
C\$DSEC		Section initialization table of initialized data area
C\$BSEC		Section initialization table of uninitialized data area
C\$VECT		Relocatable vector area
D		Initialized data area (ALIGN = 4)
P		Program area
PIntPRG		Program area (interrupt program)
FIXEDVECT	FFFF FFD0h	Fixed vector area

## 5. Software Description

### 5.1 File Structure

Table 11 shows the file structure of the master device. In addition to the files listed in table 11, some files generated automatically by HEW are used as well.

**Table 11 File Structure of Master Device**

File Name	Description
resetprg.c <sup>Note: 1</sup>	Initial settings
main.c	In addition to main processing, this program handles send/receive control for communication commands transmitted to/from the slave via asynchronous serial communication, transmission control for sending the erase block number, write data size, and write data, and LED display control for both normal completion and when an error occurs.

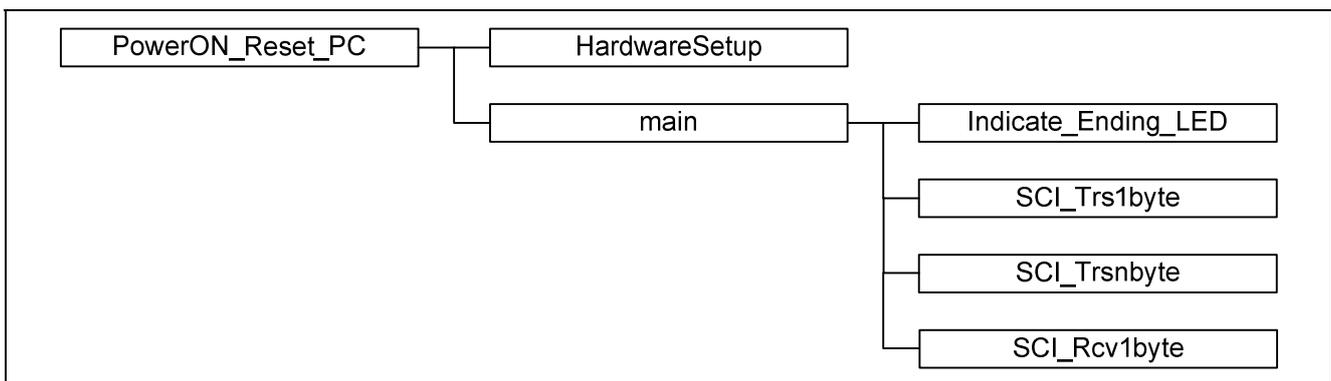
Note: 1. This file is generated automatically by HEW. In the sample program it has been edited to restore a line in the PowerON\_Reset\_PC function calling the HardwareSetup function, which was originally commented out. In the edited version the HardwareSetup function in the main.c file is called from the PowerON\_Reset\_PC function.

### 5.2 Function Structure

Table 12 lists the functions for the master device and figure 11 shows the hierarchy of these functions.

**Table 12 Master Device Functions**

Function	File Name	Description
PowerON_Reset_PC	resetprg.c	Initial settings function
HardwareSetup	main.c	MCU initial settings function
main	main.c	Main function
Indicate_Ending_LED	main.c	Normal end processing function
SCI_Trns1byte	main.c	1 byte data transmission function
SCI_Trnsnbyte	main.c	n byte data transmission function
SCI_Rcv1byte	main.c	1 byte data reception function



**Figure 11 Hierarchy of Master Device Functions**

### 5.3 Symbolic Constants

Table 13 lists the symbolic constants used by the master device.

**Table 13 Symbolic Constants of Master Device**

Symbolic Constant	Setting Value	Description	Functions Used By
FSTART	0x10	Programming/erase start command	main
ERASE	0x11	Erase start command	main
WRITE	0x12	Programming start command	main
ACCEPTABLE	0x55	Status command sent from the slave	main
LED_ON	0	Set value used when the LED is on	Indicate_Ending_LED
LED_OFF	1	Set value used when the LED is off	HardwareSetup Indicate_Ending_LED
RSK_LED0	PORT8.DR.BIT.B3	On/off control of LED 0 on the evaluation board	HardwareSetup Indicate_Ending_LED
RSK_LED1	PORT8.DR.BIT.B4	On/off control of LED 1 on the evaluation board	HardwareSetup Indicate_Ending_LED
RSK_LED2	PORT3.DR.BIT.B3	On/off control of LED 2 on the evaluation board	HardwareSetup Indicate_Ending_LED
RSK_LED3	PORT3.DR.BIT.B4	On/off control of LED 3 on the evaluation board	HardwareSetup Indicate_Ending_LED
RSK_LED0_DDR	PORT8.DDR.BIT.B3	I/O control for LED 0 on the evaluation board	HardwareSetup
RSK_LED1_DDR	PORT8.DDR.BIT.B4	I/O control for LED 1 on the evaluation board	HardwareSetup
RSK_LED2_DDR	PORT3.DDR.BIT.B3	I/O control for LED 2 on the evaluation board	HardwareSetup
RSK_LED3_DDR	PORT3.DDR.BIT.B4	I/O control for LED 3 on the evaluation board	HardwareSetup
FALL_EDGE	1	Falling edge setting	HardwareSetup
RISE_EDGE	2	Rising edge setting	HardwareSetup
SW_ON	1	START_SW_IRQ value when the IRQ switch is on	—
SW_OFF	0	START_SW_IRQ value when the IRQ switch is off	HardwareSetup
START_SW_IRQ	ICU.IR[IR_ICU_IRQ8].BIT.IR	IRQ switch state	main
START_SW_PFC	IOPORT.PFCR8.BIT.ITS8	IRQ switch pin selection	HardwareSetup
START_SW_ICR	PORT.PFCR8.BIT.B0	IRQ switch input buffer setting	HardwareSetup
START_SW_IRQMD	ICU.IRQCR[8].BIT.IRQMD	IRQ switch detection setting	HardwareSetup
START_SW_IRQEN	ICU.IRQER[8].BIT.IRQEN	IRQ switch detection enable setting	HardwareSetup

**RX610 Group On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)**

<b>Symbolic Constant</b>	<b>Setting Value</b>	<b>Description</b>	<b>Functions Used By</b>
EB27_INDEX	0x00	Erasure block data transmitted to specify the erasure block of the slave to be programmed/erased	main
EB26_INDEX	0x01		
EB25_INDEX	0x02		
EB24_INDEX	0x03		
EB23_INDEX	0x04		
EB22_INDEX	0x05		
EB21_INDEX	0x06		
EB20_INDEX	0x07		
EB19_INDEX	0x08		
EB18_INDEX	0x09		
EB17_INDEX	0x0A		
EB16_INDEX	0x0B		
EB15_INDEX	0x0C		
EB14_INDEX	0x0D		
EB13_INDEX	0x0E		
EB12_INDEX	0x0F		
EB11_INDEX	0x10		
EB10_INDEX	0x11		
EB09_INDEX	0x12		
EB08_INDEX	0x13		
EB07_INDEX	0x14		
EB06_INDEX	0x15		
EB05_INDEX	0x16		
EB04_INDEX	0x17		
EB03_INDEX	0x18		
EB02_INDEX	0x19		
EB01_INDEX	0x1A		
EB00_INDEX	0x1B		
WAIT_SCI1BIT	1920	Standby time data used after setting the SCI0 BRR register	HardwareSetup
WAIT_LED	2000000	LED illumination interval data for indication of successful completion of programming/erasing of slave user MAT	Indicate_Ending_LED
TRS_SIZE	256	Write data transmit size	main
BUF_SIZE	8192	Write buffer size	main
WRITE_SIZE	BUF_SIZE	Write data storage area size	main

## 5.4 Constant Variables

Table 14 lists the constant variables used by the master device.

**Table 14 Constant Variables of Master Device**

Constant	Type	Description
SAMPLE_DATA[BUF_SIZE]	const unsigned char	Write data (8,192) to be sent to the slave for programming the user MAT

## 5.5 RAM Variables

The master program portion of the sample program does not use RAM variables.

## 5.6 I/O Registers

The I/O registers of the master device used by the sample program are listed below. Note that the setting values shown are those used in the sample program and differ from the initial setting values.

### (1) Clock Generation Circuit

#### System Clock Control Register (SCKCR)

Number of Bits: 32 Address: 0008 0020h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b11 to b8	PCK[3:0]	0001	Peripheral module clock (PCLK) select bits	0001: × 4 PCLK = 50 MHz (when EXTAL clock = 12.5 MHz)	R/W
b19 to b16	BCK[3:0]	0010	External bus clock (BCLK) select bits	0010: × 2 BCLK = 25 MHz (when EXTAL clock = 12.5 MHz)	R/W
b23	PSTOP1	0	BCLK output stop bit	0: BCLK output	R/W
b27 to b24	ICK[3:0]	0000	System clock (ICLK) select bits	0000: × 8 ICLK = 100 MHz (when EXTAL clock = 12.5 MHz)	R/W

### (2) I/O Ports

#### Port 8 Data Register (P8.DR)

Number of Bits: 8 Address: 0008 C028h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b3	B3	0	P83 output data storage bit	0: Output data = 0	R/W
		1		1: Output data = 1	
b4	B4	0	P84 output data storage bit	0: Output data = 0	R/W
		1		1: Output data = 1	

**RX610 Group On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)****Port 3 Data Register (P3.DR) Number of Bits: 8 Address: 0008 C023h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b3	B3	0	P33 output data storage bit	0: Output data = 0	R/W
		1		1: Output data = 1	
b4	B4	0	P34 output data storage bit	0: Output data = 0	R/W
		1		1: Output data = 1	

**Port 8 Data Direction Register (P8.DDR) Number of Bits: 8 Address: 0008 C008h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b3	B3	1	P83 I/O select bit	1: Output port	R/W
b4	B4	1	P84 I/O select bit	1: Output port	R/W

**Port 3 Data Direction Register (P3.DDR) Number of Bits: 8 Address: 0008 C003h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b3	B3	1	P33 I/O select bit	1: Output port	R/W
b4	B4	1	P34 I/O select bit	1: Output port	R/W

**Port Function Register 8 (PF8IRQ) Number of Bits: 8 Address: 0008 C108h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	ITS8	0	IRQ8 pin select bit	0: P00 set as IRQ8-A input pin	R/W

**Port 0 Input Buffer Control Register (P0.ICR) Number of Bits: 8 Address: 0008 C060h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	B0	1	P00 input buffer control bit	1: P00 input buffer enabled	R/W

**Port 2 Input Buffer Control Register (P2.ICR) Number of Bits: 8 Address: 0008 C062h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b1	B1	1	P21 input buffer control bit	1: P21 input buffer enabled	R/W

**(3) Low Power Consumption**
**Module Stop Control Register B (MSTPCRB)**
**Number of Bits: 32 Address: 0008 0014h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b31	MSTPB31	0	Serial communication interface 0 module stop setting bit	0: SCI0 module stop state canceled	R/W

**(4) Serial Communications Interface 0 (SCI0)**
**SCI0 Serial Control Register (SCI0.SCR)**
**Number of Bits: 8 Address: 0008 8242h**
**(Serial communication interface mode (SMIF bit in SCI0.SCMR = 0))**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b1, b0	CKE[1:0]	00	Clock enable bits	(For asynchronous communication) 00: Internal baud rate generator The SCK0 pin is set to be an I/O port.	R/W Note: 1
b2	TEIE	0	Transmit end interrupt enable bit	0: TEI0 interrupt disabled	R/W
b4	RE	0 1	Receive enable bit	0: Serial reception disabled 1: Serial reception enabled	R/W Note: 2
b5	TE	0 1	Transmit enable bit	0: Serial transmission disabled 1: Serial transmission enabled	R/W Note: 2
b6	RIE	0 1	Receive interrupt enable bit	0: RXI0 and REI0 interrupts disabled 1: RXI0 and REI0 interrupts enabled	R/W
b7	TIE	0 1	Transmit interrupt enable bit	0: TXI0 interrupt disabled 1: TXI0 interrupt enabled	R/W

Notes: 1. Writing to these bits is possible only when the TE and RE bits are both cleared to 0.

2. A value of 1 may be written to either these bits only when the TE and RE bits are both cleared to 0. Also, 0 may be written to both the TE and RE bits after one of them has been set to 1.

## RX610 Group On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)

**SCI0 Serial Mode Register (SCI0.SMR) Number of Bits: 8 Address: 0008 8240h**

(Serial communication interface mode (SMIF bit in SCI0.SCMR = 0))

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b1, b0	CKS[1:0]	00	Clock select bit	00: PCLK clock ( $n = 0$ ) <sup>Note: 1</sup>	R/W Note: 2
b3	STOP	0	Stop bits length select bit	(Only in asynchronous communication mode) 0: One stop bit	R/W Note: 2
b5	PE	0	Parity enable bit	(Only in asynchronous communication mode) <ul style="list-style-type: none"><li>• Transmission</li></ul> 0: No parity bits <ul style="list-style-type: none"><li>• Reception</li></ul> 0: Reception with no parity	R/W Note: 2
b6	CHR	0	Character length bit	(Only in asynchronous communication mode) 0: Transmission and reception with an 8-bit data length	R/W Note: 2
b7	CM	0	Communication mode bit	0: Asynchronous mode	R/W Note: 2

Notes: 1. For information on  $n$  setting values, see the Hardware Manual listed in 7, Reference Documents.

2. Writing to these bits is possible only when the TE and RE bits in SCI0.SCR are both cleared to 0 (serial transmission and serial reception both disabled).

**SCI0 Smart Card Mode Register (SCI0.SCMR) Number of Bits: 8 Address: 0008 8246h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	SMIF	0	Smart card interface mode select bit	0: Serial communication interface mode	R/W Note: 1
b3	SDIR	0	Bit order selection bit	0: LSB-first transmission/reception	R/W Note: 1

Note: 1. Writing to this bit is possible only when the TE and RE bits in SCI0.SCR are both cleared to 0 (serial transmission and serial reception both disabled).

**SCI0 Bit Rate Register (SCI0.BRR) Number of Bits: 8 Address: 0008 8241h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b7 to b0	—	00110001 Note: 1	—	31h: Bit rate = 31,250 bps (When PCLK is 50 MHz)	R/W Note: 2

Notes: 1. For information on *BRR* setting values, see the Hardware Manual listed in 7, Reference Documents.

2. While this register can be read at any time, it can only be written when both the SCI0.SCR.TE bit and the SCI0.SCR.RE bits are 0 (serial transmission disabled and serial reception disabled).

## **RX610 Group** On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)

**SCI0 Serial Status Register (SCI0.SSR)** Number of Bits: 8 Address: 0008 8244h

(Serial communication interface mode (SMIF bit in SCI0.SCMR = 0))

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b2	TEND	—	Transmit end flag	0: Character transmission in progress 1: Character transmission finished	R
b4	FER	— Note: 1	Framing error flag	0: No framing error occurred 1: A framing error occurred	R/(W) Note: 2
b5	ORER	— Note: 1	Overrun error flag	0: No overrun error occurred 1: An overrun error occurred	R/(W) Note: 2

Notes: 1. The FER and ORER bits are handled as read-only in this application note. Writing to these bits to clear the flags to 0 is not performed.

2. Only writing 0 to clear the flag is allowed.

**SCI0 Transmit Data Register (SCI0.TDR)** Number of Bits: 8 Address: 0008 8243h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b7 to b0	—	— Note: 1	—	Stores transmit data.	R/W

Note: 1. The transmitted data is stored in this field.

**SCI0 Receive Data Register (SCI0.RDR)** Number of Bits: 8 Address: 0008 8245h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b7 to b0	—	—	—	Stores receive data.	R

### (5) Interrupt Control Unit (ICU)

**Interrupt Priority Register 80 (IPR80)** Number of Bits: 8 Address: 0008 7380h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b2 to b0	IPR[2:0]	000	SCI0 Interrupt priority level setting bits	000: Level 0 (interrupt disabled)	R/W

**IRQ Control Register (IRQCR8)** Number of Bits: 8 Address: 0008 C328h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b3, b2	IRQMD[1:0]	01	IRQ8 detection select bits	01: Falling edge	R/W

**IRQ Detection Select Register (IRQER8)** Number of Bits: 8 Address: 0008 C308h

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	IRQEN	1	IRQ8 detection select bits	1: Detection of external interrupt sources by using the IRQ8 pin enabled	R/W

## RX610 Group On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Master)

**Interrupt Request Enable Register 1A (IER1A)**      **Number of Bits: 8**      **Address: 0008 721Ah**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b7	IEN7	0	RX10 Interrupt request enable bit 7	0: RX10 interrupt disabled	R/W

**Interrupt Request Enable Register 1B (IER1B)**      **Number of Bits: 8**      **Address: 0008 721Bh**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	IEN0	0	TX10 Interrupt request enable bit 0	0: TX10 interrupt disabled	R/W

**Interrupt Request Register 072 (IR072)**      **Number of Bits: 8**      **Address: 0008 7048h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	IR	0	IRQ8 Interrupt status flag	0: No IRQ8 interrupt request 1: IRQ8 interrupt request	R/(W) *1

Note: 1. Only 0 may be written to this bit to clear the flag. Writing 1 is prohibited.

**Interrupt Request Register 215 (IR215)**      **Number of Bits: 8**      **Address: 0008 70D7h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	IR	0	RX10 Interrupt status flag	0: No RX10 interrupt request 1: RX10 interrupt request	R/(W) *1

Note: 1. Only 0 may be written to this bit to clear the flag. Writing 1 is prohibited.

**Interrupt Request Register 216 (IR216)**      **Number of Bits: 8**      **Address: 0008 70D8h**

Bit	Symbol	Setting Value	Bit Name	Function	R/W
b0	IR	0	TX10 Interrupt status flag	0: No TX10 interrupt request 1: TX10 interrupt request	R/(W) *1

Note: 1. Only 0 may be written to this bit to clear the flag. Writing 1 is prohibited.

## 5.7 Function Specifications

The specifications of the master device functions are as follows.

### (1) PowerON\_Reset\_PC Function

#### (a) Functional overview

The PowerON\_Reset\_PC function initializes the stack pointer (a #pragma entry declaration causes the compiler automatically to generate ISP/USP initialization code at the start of the PowerON\_Reset\_PC function), sets INTB (set\_intb function: embedded function), initializes FPSW (set\_fpsw function: embedded function), initializes the RAM area section (\_INITSCT function: standard library function), calls the HardwareSetup function, initializes PSW (set\_psw function: embedded function), and sets user mode as the processor mode. Then it calls the main function.

#### (b) Arguments

None

#### (c) Return values

None

#### (d) Flowchart

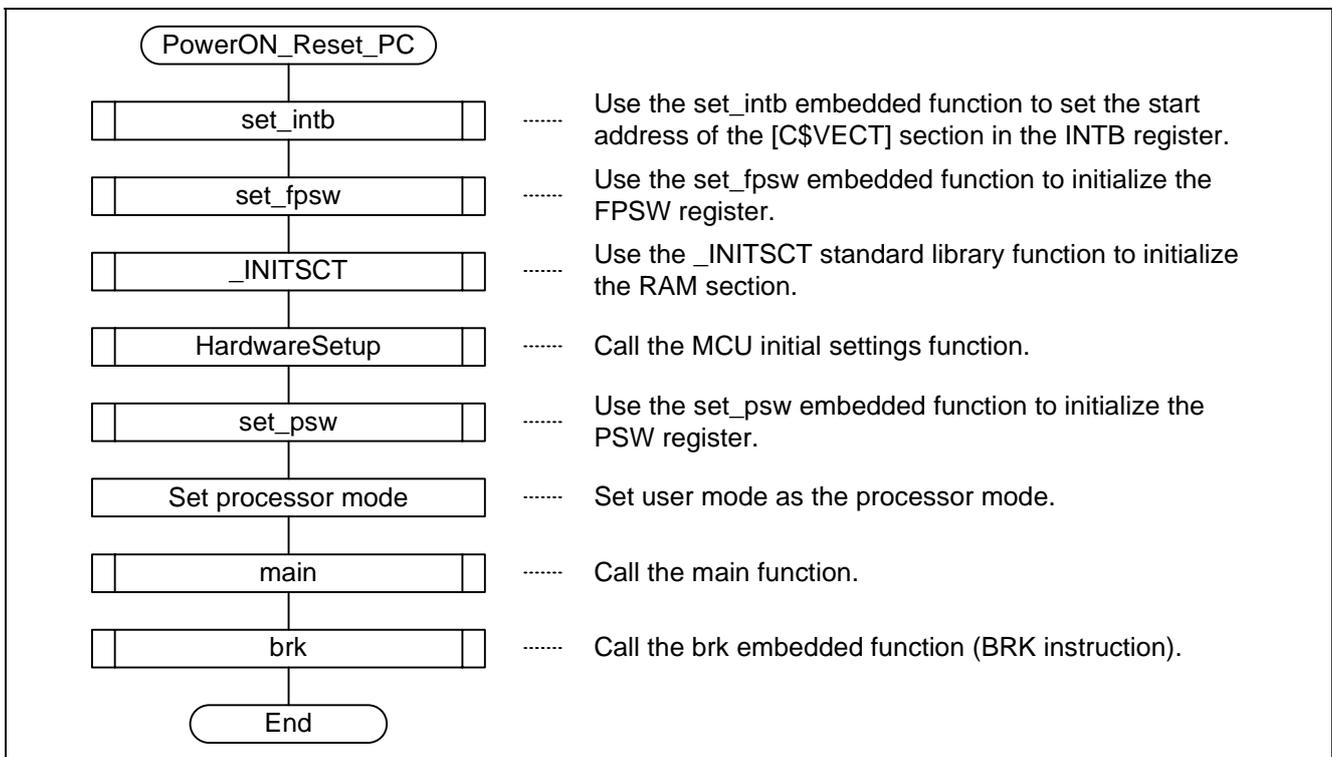


Figure 12 Flowchart (PowerON\_Reset\_PC) (Master)

**(2) HardwareSetup Function**

**(a) Functional overview**

The HardwareSetup function makes initial settings to the MCU. It makes initial clock settings (system clock (ICLK), peripheral module clock (PCLK), and external bus clock (BCLK)), initial I/O settings for the I/O ports (P83, P84, P33, and P36) connected to LED0 to LED3, the initial I/O port function setting for the pin (P00/IRQ8-A) connected to the IRQ switch, and initial settings to SCI0.

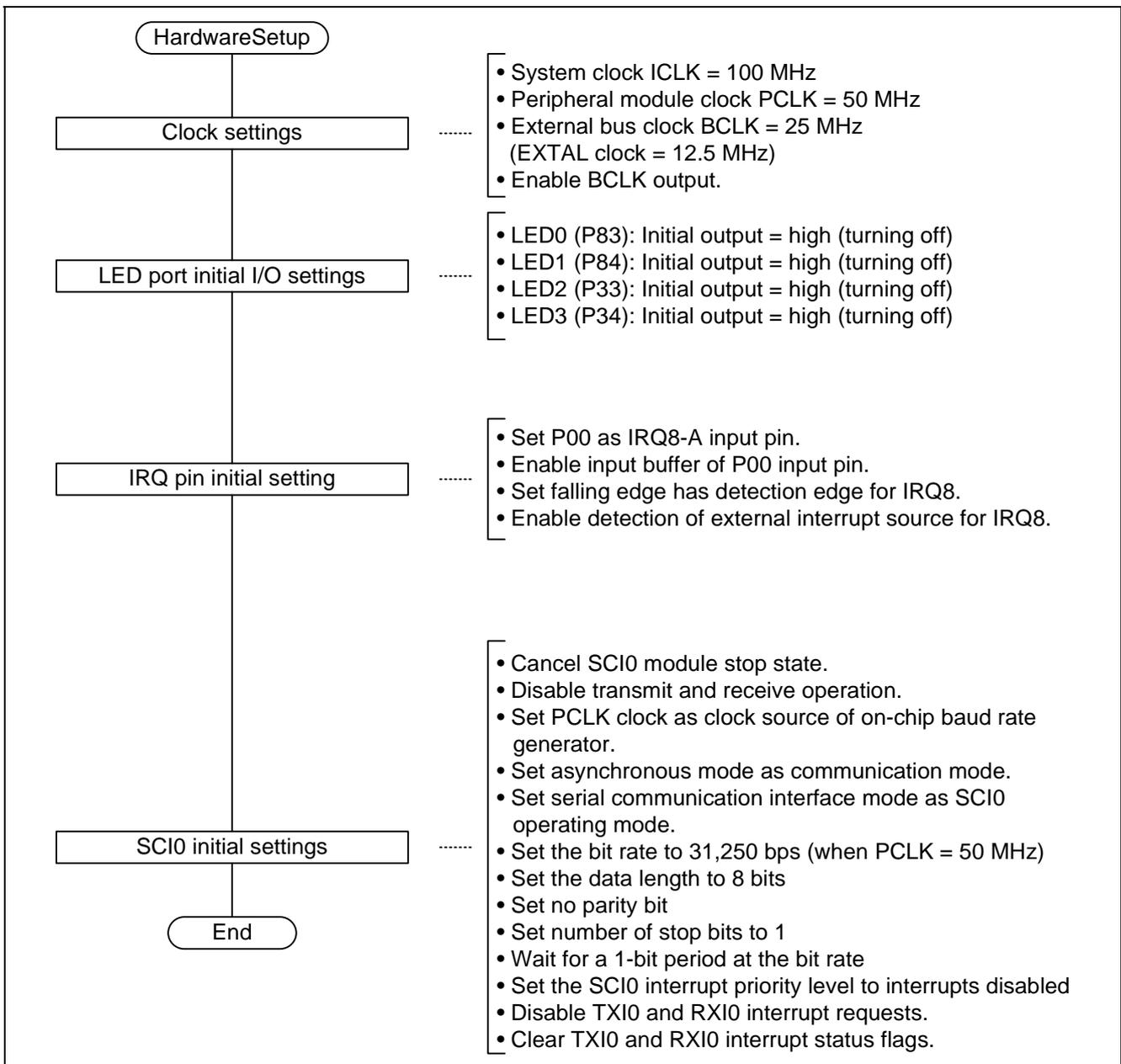
**(b) Arguments**

None

**(c) Return values**

None

**(d) Flowchart**



**Figure 13 Flowchart (HardwareSetup) (Master)**

**(3) main Function**

**(a) Functional overview**

The main function determines when the IRQ switch has been pressed, controls transmission and reception of communications commands to and from the slave, controls transmission of erasure block number, controls transmission of write size data, controls transmission of write data, controls reception of [ACCEPTABLE] commands sent from the slave, and calls the Indicate\_Ending\_LED at normal end.

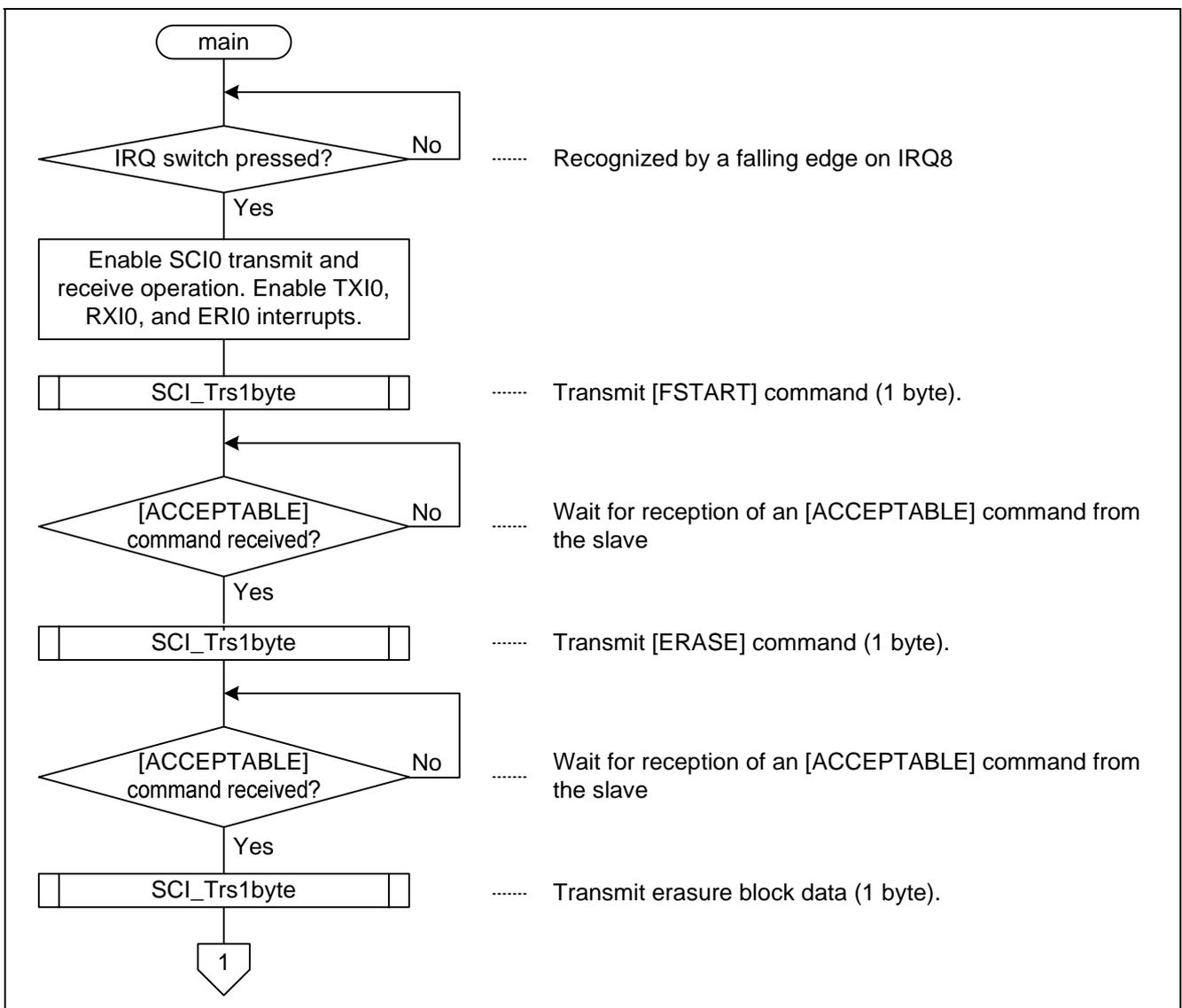
**(b) Arguments**

None

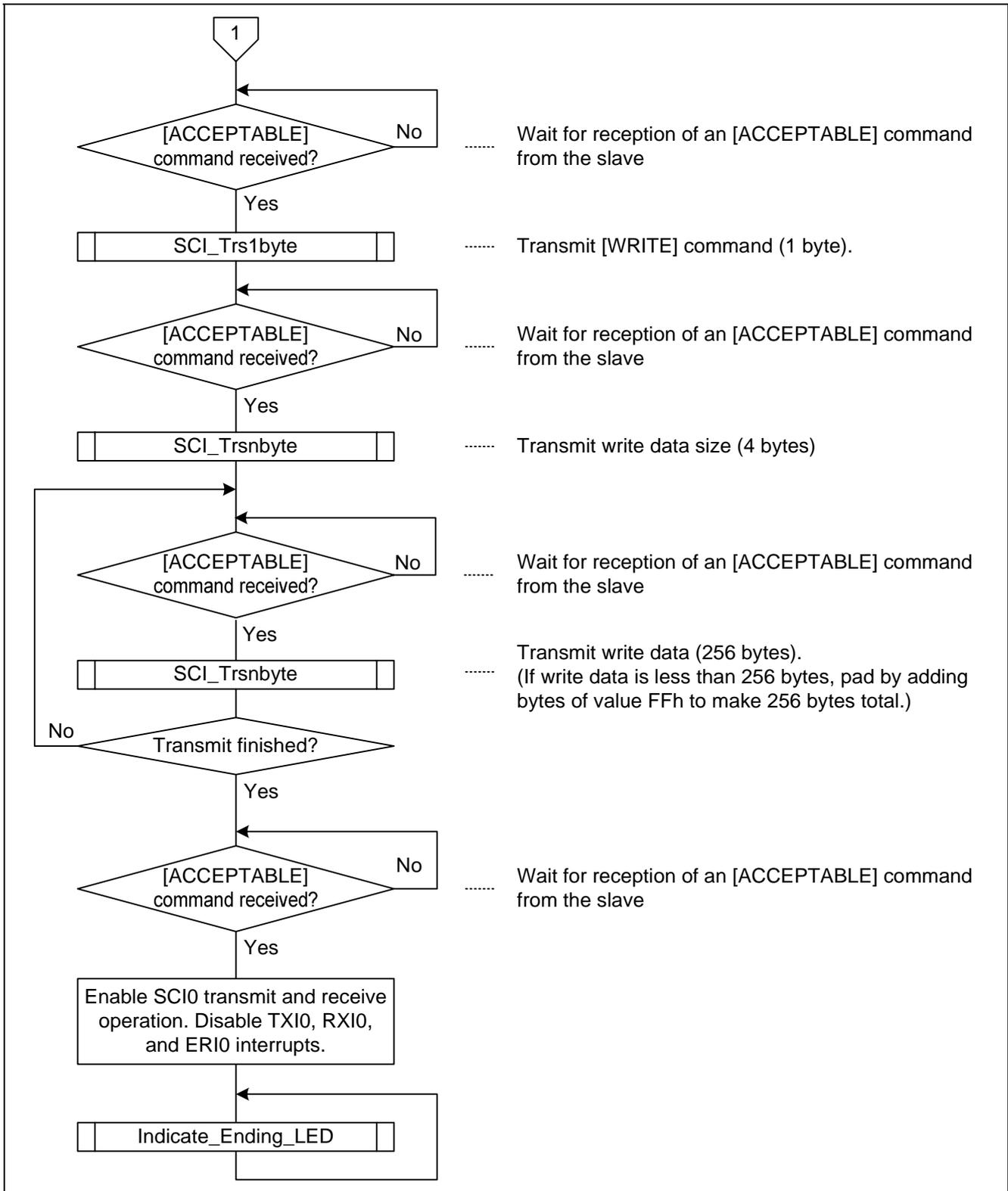
**(c) Return values**

None

**(d) Flowchart**



**Figure 14 Flowchart (main) (1) (Master)**



**Figure 15 Flowchart (main) (2) (Master)**

**(4) Indicate\_Ending\_LED Function**

**(a) Functional overview**

When programing/erasing of the slave's user MAT completes successfully, the Indicate\_Ending\_LED function indicates a normal end using LED0 to LED3. The function illuminates LED0 to LED3 one at a time in sequence.

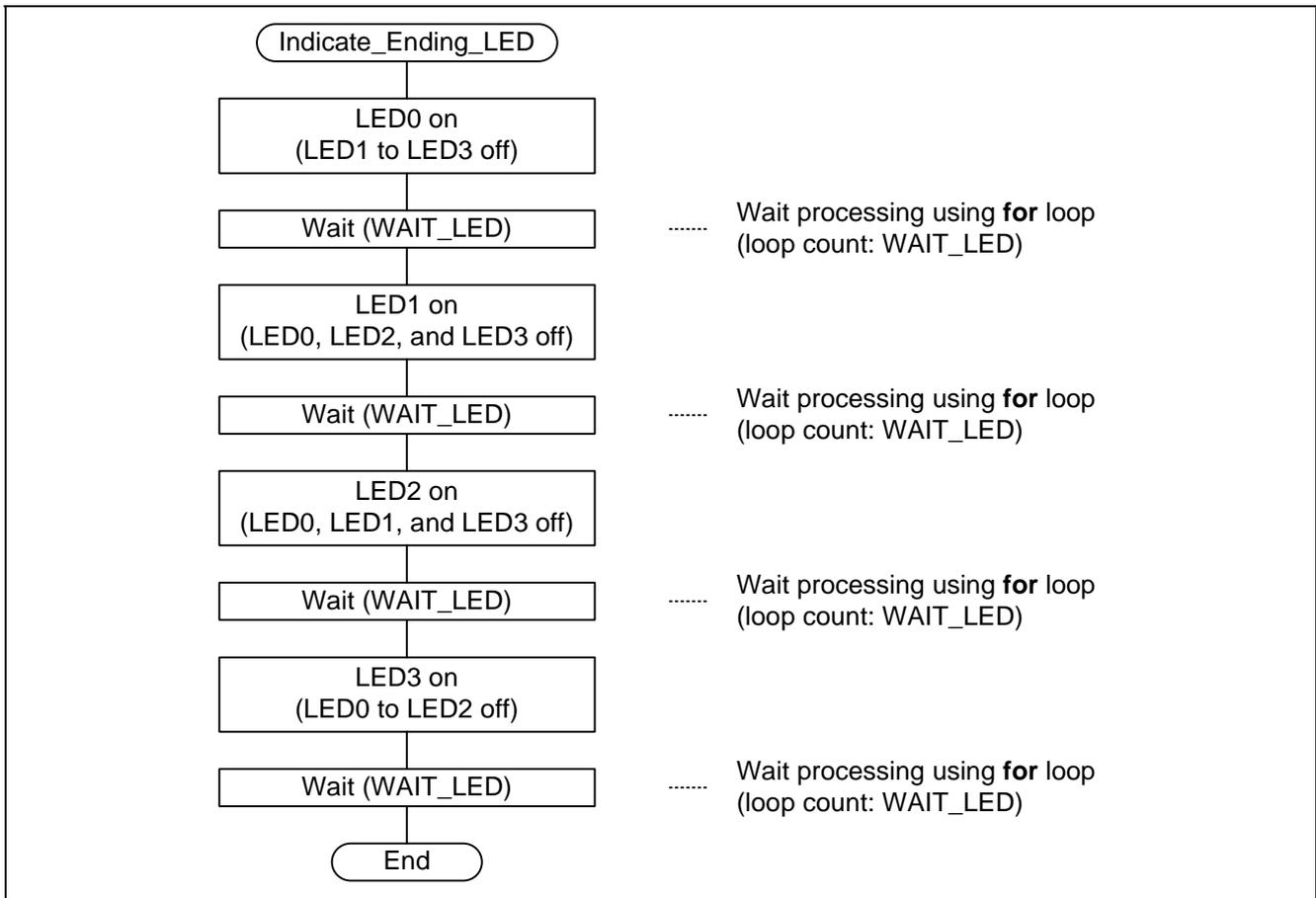
**(b) Arguments**

None

**(c) Return values**

None

**(d) Flowchart**



**Figure 16 Flowchart (Indicate\_Ending\_LED) (Master)**

**(5) SCI\_Trns1byte Function**

**(a) Functional overview**

The SCI\_Trns1byte function controls transmission of one byte of data using asynchronous serial communication by SCI0.

**(b) Arguments**

Table 15 lists the arguments used by this function.

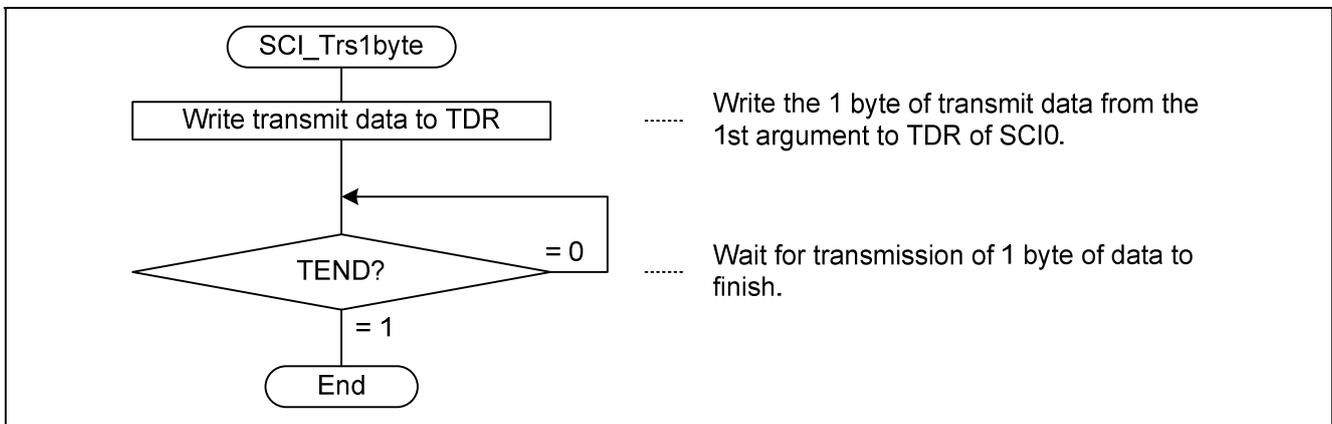
**Table 15 Arguments of SCI\_Trns1byte Function**

Arguments	Type	Description
1st argument	unsigned char	Transmit data byte count obtained using asynchronous serial communication by SCI0

**(c) Return values**

None

**(d) Flowchart**



**Figure 17 Flowchart (SCI\_Trns1byte) (Master)**

**(6) SCI\_Trnsbyte Function**

**(a) Functional overview**

The SCI\_Trnsbyte uses the asynchronous serial communication function of the SCI0 to control transmission of n bytes (n is the first argument and unsigned short type).

**(b) Arguments**

Table 16 lists the arguments used by this function.

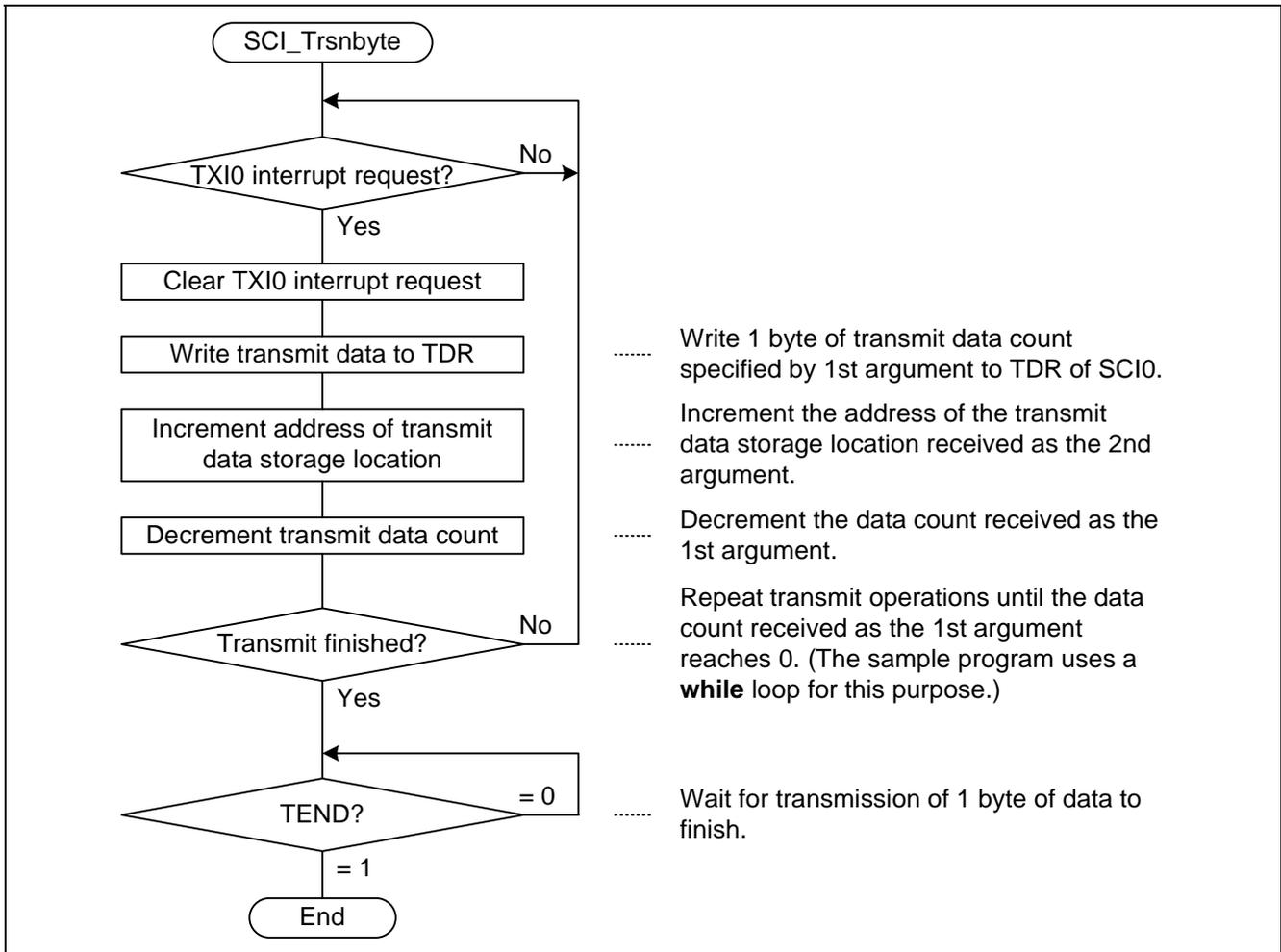
**Table 16 Arguments of SCI\_Trnsbyte Function**

Arguments	Type	Description
1st argument	unsigned short	Number of bytes of data transmitted using asynchronous serial communication function of SCI0
2nd argument	unsigned char *	Start address of storage location for transmit data

**(c) Return values**

None

**(d) Flowchart**



**Figure 18 Flowchart (SCI\_Trnsbyte) (Master)**

**(7) SCI\_Rcv1byte Function**

**(a) Functional overview**

The SCI\_Rcv1byte function performs the reception control for receiving 1 byte of data over SCI0 asynchronous serial communication.

**(b) Arguments**

None

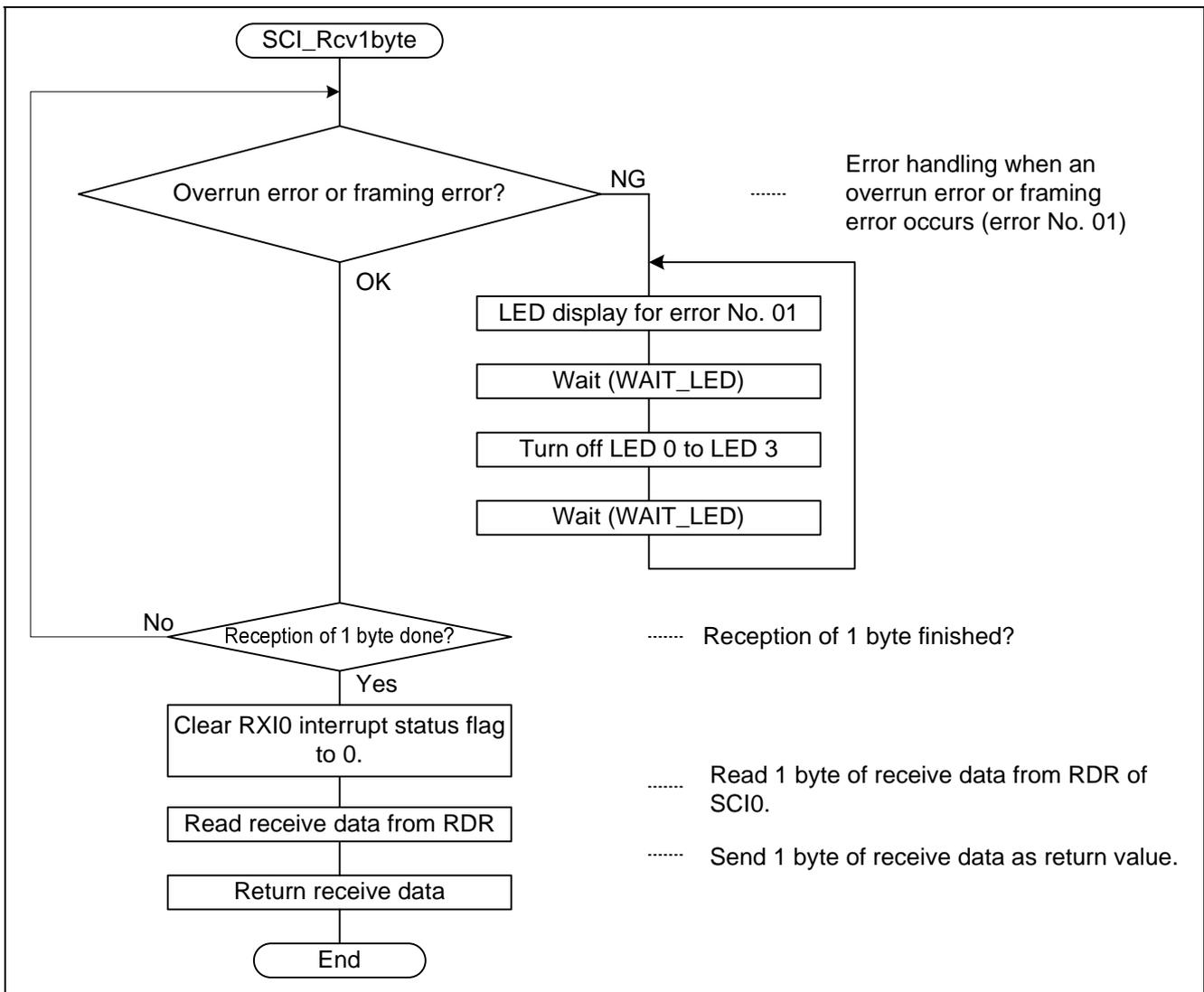
**(c) Return values**

Table 17 lists the return values used by this function.

**Table 17 Return Values SCI\_Rcv1byte Function**

Type	Description
unsigned char	The one byte of receive data from the SCI0 asynchronous serial communication.

**(d) Flowchart**



**Figure 19 Flowchart (SCI\_Rcv1byte) (Master)**

## 6. Usage Notes

### 6.1 Notes on the wait time for a 1-bit period for the bit rate at SCI0 initialization

In this application note, the 1-bit period wait time for the bit rate after setting the bit rate register (SCI0.BRR) at SCI initialization is measured using a software timer. Since the bit rate for SCI0 asynchronous serial communication is 31,250 bps, the bit period is calculated as follows.

The 1-bit period for the 31,250 bps bit rate is: 32  $\mu$ s.

In this application note, the 1-bit period wait time for the bit rate is implemented by iterating a while loop with the loop count defined by the WAIT\_SCI1BIT symbolic constant. If we take the number of cycles to execute one iteration of the while loop to be 5 cycles (which can be verified from the assembly language output by the compiler), the number of iterations can be calculated as follows.

**while** loop run count = wait duration / (cycle count per **while** loop iteration \* ICLK cycle duration)

Note that the CPU's instruction processing time can differ due to pipelining, so the above-mentioned number of cycles per **while** loop iteration (5 cycles) is a rough estimate of the instruction processing time.

In the sample program, the wait duration is calculated as 96 [ $\mu$ s] to provide a sufficient margin, as follows:

**while** loop run count = WAIT\_SCI1BIT = 96 [ $\mu$ s] / (5 \* 10 [ns]) = 1,920 (ICLK = 100 MHz)

Therefore, the symbolic constant WAIT\_SCI1BIT is defined as 1,920.

To use this application note, users should either carefully evaluate the CPU instruction execution time or use a timer to measure this time.

## **7. Reference Documents**

- Hardware Manual  
RX610 Group Hardware Manual  
(The latest version can be downloaded from the Renesas Electronics Web site.)
- Development Environment Manual  
RX Family C/C++ Compiler Package User's Manual  
(The latest version can be downloaded from the Renesas Electronics Web site.)
- Software Manual  
RX Family User's Manual: Software  
(The latest version can be downloaded from the Renesas Electronics Web site.)
- Technical Updates  
(The latest information can be downloaded from the Renesas Electronics Web site.)
- Application Note  
RX610 Group On-chip Flash Memory Reprogramming in Single Chip Mode via an UART Interface (Slave)  
(The latest information can be downloaded from the Renesas Electronics Web site.)

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## Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Feb.14.11	—	First edition issued

## General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

### 1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

### 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

### 5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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